

1 A Three-quadrant triacs high commutation Rev. 04 — 4 February 2008

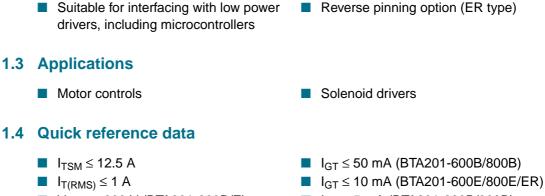
Product data sheet

Product profile 1.

1.1 General description

Passivated, guaranteed commutation triacs in a plastic package. The 'sensitive gate' E and ER series are intended for interfacing with low power drivers, including microcontrollers. The high commutation B series are designed to commutate the full RMS current at the maximum junction temperature without the aid of a snubber.

1.2 Features



- V_{DRM} \leq 600 V (BTA201-600B/E)
- V_{DRM} \leq 800 V (BTA201-800B/E/ER)
- I_{GT} ≥ 5 mA (BTA201-600B/800B)
- I_{GT} ≥ 1 mA (BTA201-600E/800E/ER)

Pinning information 2.

Table 1. Pin	ning		
Pin	Description	Simplified outline	Graphic symbol
B and E series	i i		
1	main terminal 2 (T2)		N 1
2	gate (G)		T2-T1
3	main terminal 1 (T1)		`G sym051
ER series			
1	main terminal 1 (T1)		
2	gate (G)	321	
3	main terminal 2 (T2)	SOT54 (TO-92)	



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3. Ordering information

Table 2. Ordering information							
Type number	Package	Package					
	Name	Description	Version				
BTA201-600B	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54				
BTA201-600E							
BTA201-800B							
BTA201-800E							
BTA201-800ER							

4. Limiting values

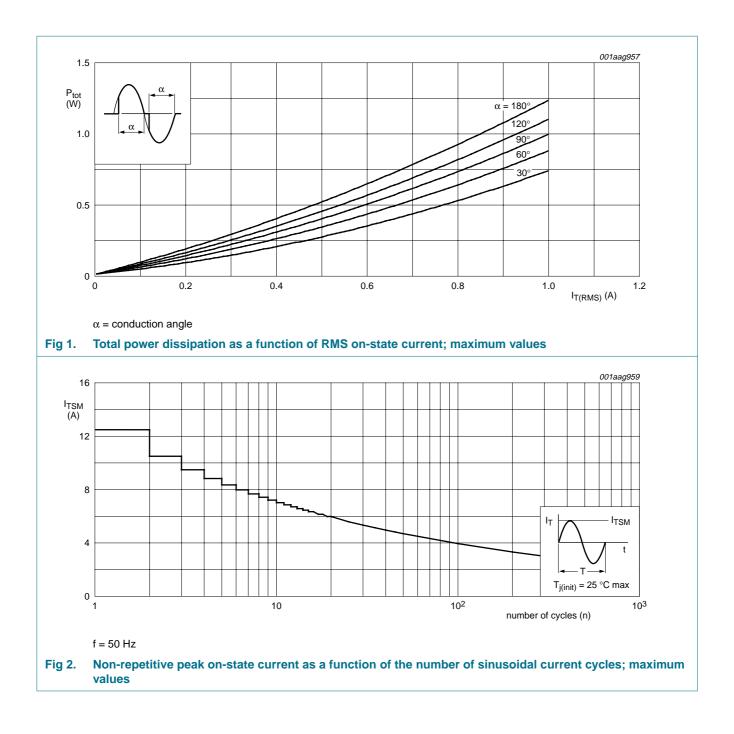
Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage				
		BTA201-600B	<u>[1]</u> _	600	V
		BTA201-600E	<u>[1]</u> _	600	V
		BTA201-800B	-	800	V
		BTA201-800E	-	800	V
		BTA201-800ER	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{lead} \le 54.3 \text{ °C}$; see Figure 4 and 5	-	1	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	12.5	А
		t = 16.7 ms	-	13.7	А
l ² t	I ² t for fusing	t _p = 10 ms	-	0.78	A ² s
dl _T /dt	rate of rise of on-state current	$\begin{split} I_{TM} &= 1.5 \text{ A}; \text{ I}_{G} = 0.2 \text{ A}; \\ dI_{G}/dt &= 0.2 \text{ A}/\mu\text{s} \end{split}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C

 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/µs.

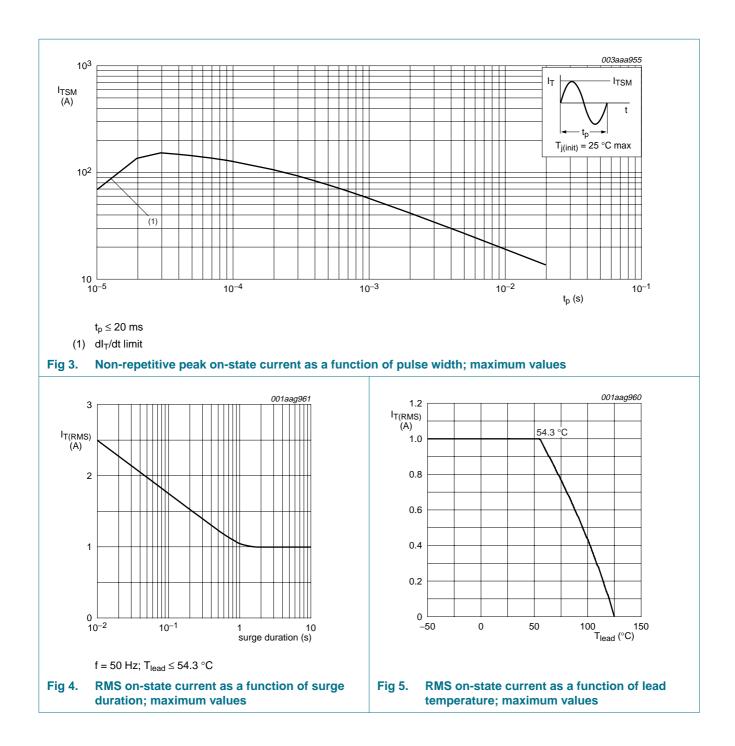
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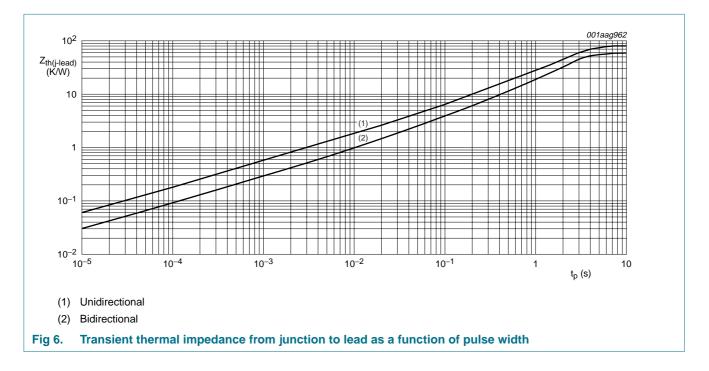
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-lead)}	load	full cycle; see Figure 6	-	-	60	K/W
		half cycle; see Figure 6	-	-	80	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W



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6. Static characteristics

Table 5. Static characteristics

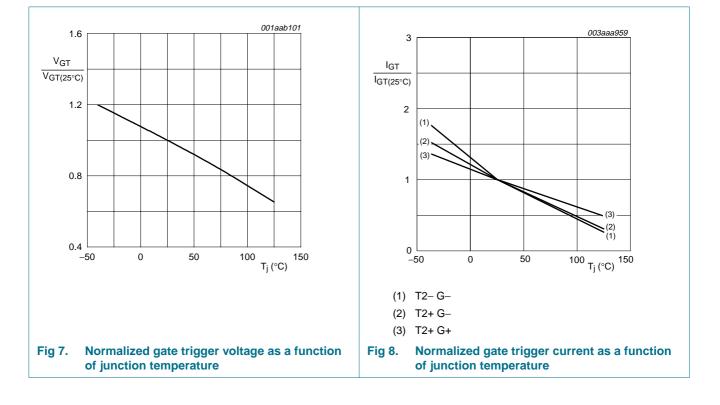
 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER		
			Min	Тур	Max	Min	Тур	Max	
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$							
		T2+ G+	5	-	50	1	-	10	mA
		T2+ G-	5	-	50	1	-	10	mA
		T2– G–	5	-	50	1	-	10	mA
۱L	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 10}}{1000000000000000000000000000000000$							
		T2+ G+	-	-	30	-	-	12	mA
		T2+ G-	-	-	50	-	-	20	mA
		T2– G–	-	-	30	-	-	12	mA
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 11}}{1000000000000000000000000000000000$	-	-	30	-	-	12	mA
VT	on-state voltage	I _T = 1.4 A; see <u>Figure 9</u>	-	1.2	1.5	-	1.2	1.5	V
V _{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.7	1.5	-	0.7	1.5	V
		V_D = 400 V; I _T = 0.1 A; T _j = 125 °C	0.2	0.3	-	0.2	0.3	-	V
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA

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7. Dynamic characteristics

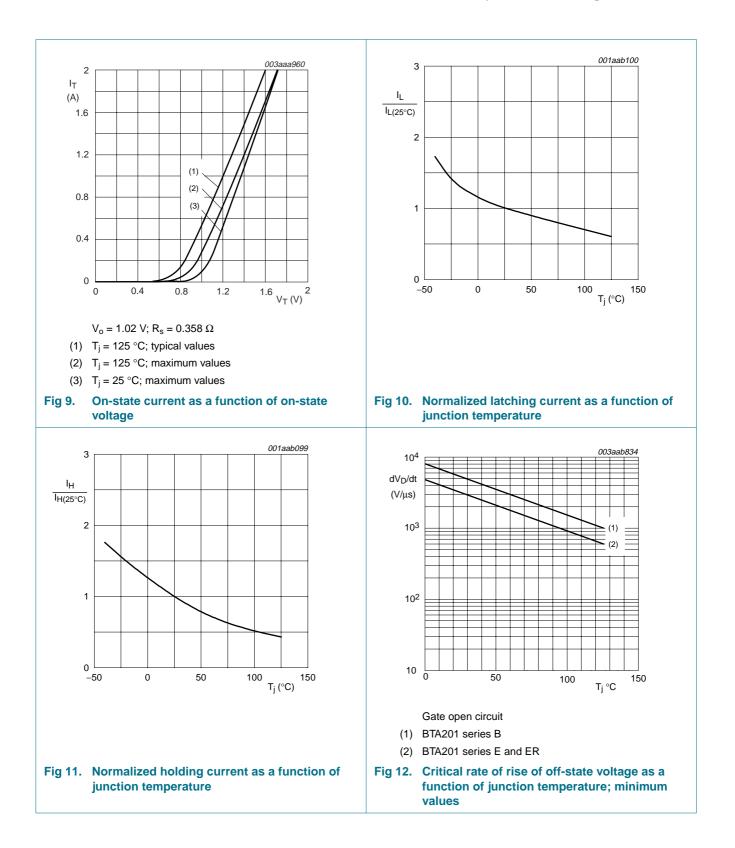
Table 6.	Dynamic characteristics								
Symbol	Parameter	Conditions		BTA201-600B BTA201-800B			BTA201-600E BTA201-800E BTA201-800ER		
			Min	Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)};$ T _j = 125 °C; exponential waveform; gate open circuit	1000	-	-	600	-	-	V/µs
	rate of change of commutating current	$V_{DM} = 400 \text{ V}; T_j = 125 \text{ °C};$ $dV_{com}/dt = 20 \text{ V}/\mu s;$ gate open circuit	12	-	-	2.5	-	-	A/ms
		$V_{DM} = 400 \text{ V}; T_j = 125 \text{ °C};$ $dV_{com}/dt = 10 \text{ V}/\mu s;$ gate open circuit	16	-	-	3.5	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A}; \\ V_D &= V_{DRM(max)}; \\ I_G &= 0.1 \text{ A}; \\ dI_G/dt &= 5 \text{ A}/\mu\text{s} \end{split}$	-	2	-	-	2	-	μs



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8. Package outline

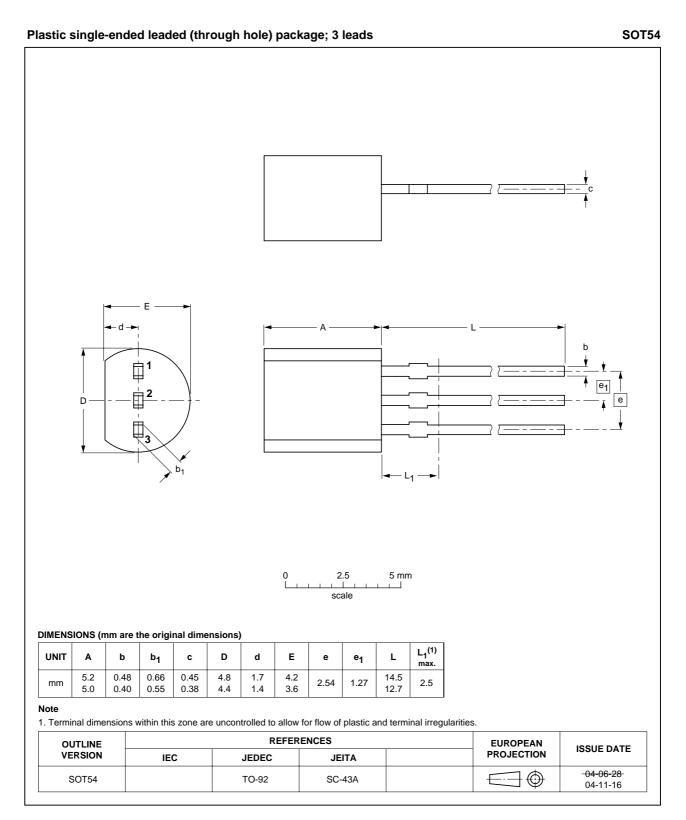


Fig 13. Package outline SOT54 (TO-92)

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9. Revision history

Table 7. Revision history	/			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA201_SER_B_E_ER_4	20080204	Product data sheet	-	BTA201_SER_B_E_ER_3
Modifications:	• Figure 3: 0	Changed figure.		
	Section 1.	4 "Quick reference data" on pa	age 1: Updated wit	h minimum I _{GT} values added.
	 <u>Table 3 "Li</u> 	miting values" on page 2: I ² t o	condition, t _p ; symbo	ol update.
	• Table 5 "S	tatic characteristics" on page	<mark>6</mark> : Minimum I _{GT} val	ues added.
BTA201_SER_B_E_ER_3	20070910	Product data sheet	-	BTA201_SER_B_E_ER_2
Modifications:		t of this data sheet has been i of NXP Semiconductors.	redesigned to com	ply with the new identity
	 Legal texts 	s have been adapted to the ne	ew company name	where appropriate.
	 Descriptive 	e titles have been corrected.		
	 Table 3 "Li 	miting values" on page 2: dl _T /	dt uprated.	
	 Table 6 "D 	ynamic characteristics" on pa	ge 7: dV _D /dt uprate	ed.
		"Critical rate of rise of off-state values" on page 8: graph upda		tion of junction temperature;
BTA201_SER_B_E_ER_2	20060113	Product data sheet	-	BTA201_SER_B_E_ER_1
Modifications:	• Figure 4: F	Figure note corrected		
	 Table 6 "D 	ynamic characteristics" on pa	ge 7: Units correcte	ed
	 Figure 12: 	Figure title corrected		
BTA201_SER_B_E_ER_1 (9397 750 15154)	20050825	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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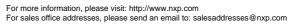
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